



DXTP03100CFG

100V PNP LOW VCESAT TRANSISTOR IN PowerDI3333-8

Features

- BV_{CEO} > -100V
- Small Form Factor Thermally Efficient Package.
 Enables Higher Density End Products
- I_C = -5A Continuous Collector Current
- I_{CM} = -10A Peak Pulse Current
- Low Saturation Voltage V_{CE(sat)} < -100mV @ -1A
- R_{SAT} = 60mΩ for a Low equivalent On-Resistance
- hFE Specified up to -10A for a High Gain Hold-Up
- Complementary NPN Type: DXTN03100CFG
- Rated to +175°C Ideal For High Temperature Environment
- Wettable Flank For Improved Optical Inspection
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: PowerDl[®]3333-8
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads Solderable per MIL-STD-202, Method 208 ⁽³⁾
- Weight: 0.03 grams (Approximate)

Applications

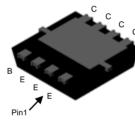
- Motor Driving
- Line Switching
- High Side Switches

PowerDI3333-8 (SWP) (Type UX)

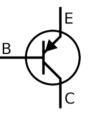
Equivalent Circuit



Top View



Bottom View



Device Symbol

Ordering Information (Note 4)

Part Number	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DXTP03100CFG-7	2K1	7	12	2,000
Notes: 1 No purposely added lead Fully FLI Directive 2002/95/FC (RoHS) 2011/65/FLI (RoHS 2) & 2015/863/FLI (RoHS 3) compliant				

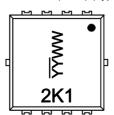
No pulposely added lead. Fully ED Directive 2002/95/EC (ROHS), 2017/95/ED (ROHS 2) & 2015/965/ED (ROHS 3) Compliant.
 See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

PowerDI3333-8 (SWP) (Type UX)



2K1= Product Type Marking Code $\overline{YY}WW = Date Code Marking$ $\overline{YY} = Last Two Digits of Year (ex: 19 = 2019)$ WW = Week Code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-110	V
Collector-Emitter Voltage	V _{CEO}	-100	V
Emitter-Base Voltage	V _{EBO}	-7	V
Continuous Collector Current	lc	-5	A
Peak Pulse Current	ICM	-10	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
	(Note 5)		1.07	W
Power Dissipation	(Note 6)	PD	2.3	W
	(Note 7)		3.4	W
	(Note 5)		140	°C/W
Thermal Resistance, Junction to Ambient	(Note 6)	R _{0JA}	65	°C/W
	(Note 7)		44	°C/W
Thermal Resistance, Junction to Leads (Note 8	R _{θJL}	6	°C/W	
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +175	°C	

ESD Ratings (Note 9)

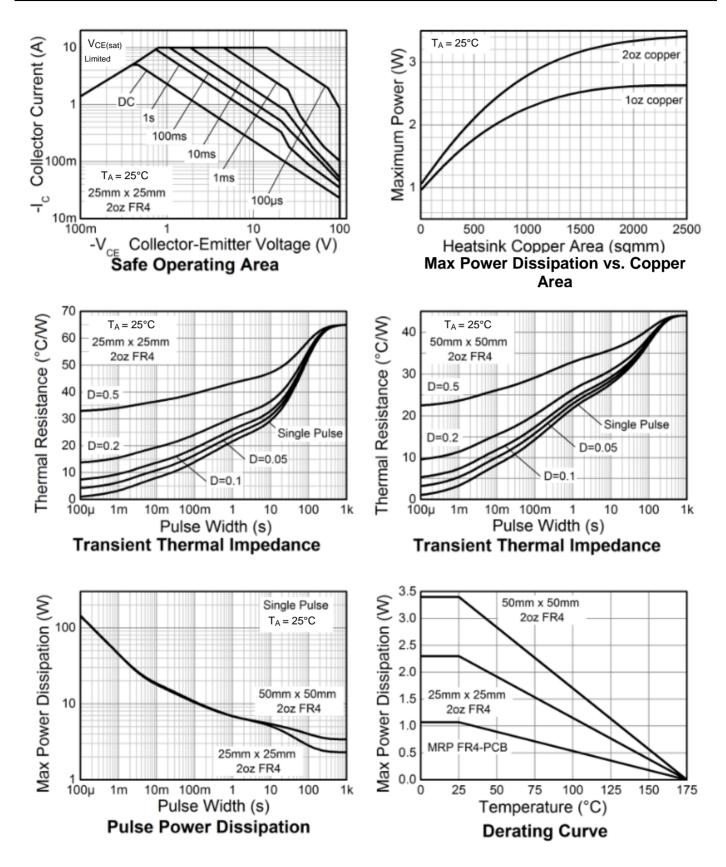
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	ЗA
Electrostatic Discharge - Machine Model	ESD MM	≥ 400	V	С
Notes: 5. For a device mounted with the collector tab on MRP FR-4 PCB; device is measured under still air conditions whilst operating in a steady-state.				

5. For a device mounted with the collector tab on MRP FR-4 PCB; device is measured under still air conditions whilst operating in a steady-state.

For a device mounted with the collector tab on MKP FR-4 PCS; device is meas
 Same as Note 5, except the device is mounted on 25mm x 25mm 2oz copper.
 Same as Note 5, except the device is mounted on 50mm x 50mm zoz copper.
 Thermal resistance from junction to solder-point (at the collector tab).
 Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristics and Derating Information





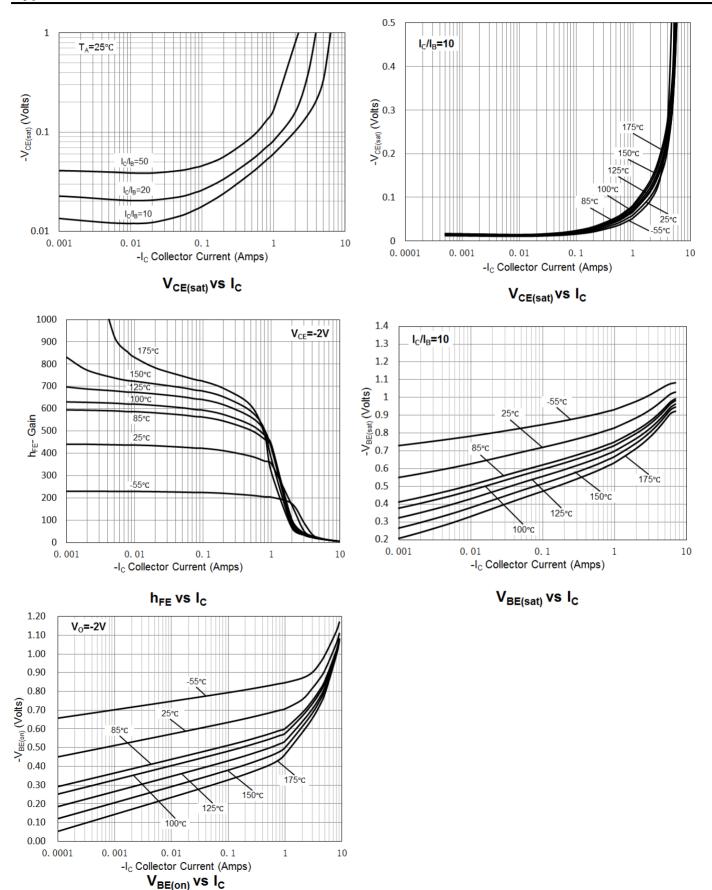
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	-110	-138		V	I _C = -100μA
Collector-Emitter Breakdown Voltage (Note 10)	BV _{CEO}	-100	-116	-	V	I _C = -10mA
Emitter-Base Breakdown Voltage	BV _{EBO}	-7	-8.8		V	I _E = -100μA
Callester Deep Cut Off Current	Ісво	_	-1	-50	nA	V _{CB} = -100V
Collector-Base Cut-Off Current		_	-0.07	10	μA	V _{CB} = -100V, T _A = +125°C
Collector Emitter Cut Off Current ($B < 1kO$)		_	-2	-50	nA	V _{CB} = -100V
Collector-Emitter Cut-Off Current ($R \le 1k\Omega$)	I _{CER}		-2.3	50	μA	V _{CB} = -100V, T _A = +125°C
Emitter Cut-Off Current	I _{EBO}	_	-1	-20	nA	$V_{EB} = -6V$
		250	421	_	_	$I_{C} = -10 \text{mA}, V_{CE} = -2 \text{V}$
		200	338	800	_	$I_{C} = -1A, V_{CE} = -2V$
Statia Famulard Current Transfer Datia (Nata 10)		180	323		_	I _C = -1.2A, V _{CE} = -2V
Static Forward Current Transfer Ratio (Note 10)	h _{FE}	150	295	-	_	I _C = -1.5A, V _{CE} = -2V
		35	57	-	_	$I_{C} = -3A, V_{CE} = -2V$
		20	29		_	$I_{C} = -4A, V_{CE} = -2V$
	V _{CE(sat)}	—	-17.5	-40	mV	I _C = -100mA, I _B = -10mA
Collector Emitter Seturation Valence (Note 10)		—	-60	-100	mV	I _C = -1A, I _B = -100mA
Collector-Emitter Saturation Voltage (Note 10)		_	-102	-180	mV	I _C = -2A, I _B = -200mA
		—	-212	-380	mV	$I_{\rm C} = -4A, I_{\rm B} = -400 {\rm mA}$
Base-Emitter Saturation Voltage (Note 10)	V _{BE(sat)}	_	-963	-1.1	mV	$I_{\rm C} = -4A, I_{\rm B} = -400 {\rm mV}$
Base-Emitter Turn-On Voltage (Note 10)	V _{BE(on)}	—	-888	-1	mV	$I_{C} = -4A, V_{CE} = -2V$
Output Capacitance	Cobo	—	42	_	pF	V _{CB} = -10V. f = 1MHz
Transition Frequency	f⊤	—	125	—	MHz	V _{CE} = -10V, I _C = -100mA f = 50MHz
	t _{delay}	_	6.8	—	ns	
Switching Characteristics	t _{rise}	—	259	_	ns	V _{CC} = -10V, I _C = -1A
	t _{storage}	_	1718	—	ns	$I_{B1} = -I_{B2} = -100 \text{mA}$
	t _{fall}	_	185	—	ns	

Note: 10. Measured under pulsed conditions. Pulse width \leqslant 300µs. Duty cycle \leqslant 2%.



Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

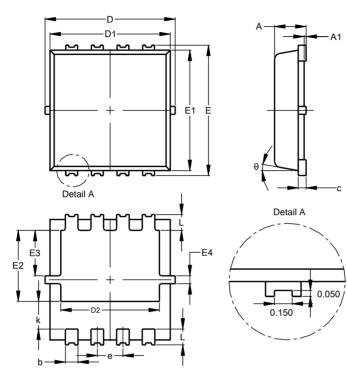




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (SWP) (Type UX)

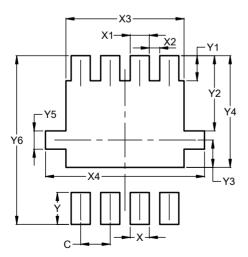


PowerDI3333-8 (SWP)						
	(Type UX)					
Dim	Min Max Typ					
Α	0.75	0.85	0.80			
A1	0.00	0.05				
b	0.25	0.40	0.32			
C	0.10	0.25	0.15			
D	3.20	3.40	3.30			
D1	2.95	3.15	3.05			
D2	2.30	2.70	2.50			
Е	3.20	3.40	3.30			
E1	2.95	3.15	3.05			
E2	1.60	2.00	1.80			
E3	0.95	1.35	1.15			
E4	0.10	0.30	0.20			
е			0.65			
k	0.50	0.90	0.70			
_	0.30	0.50	0.40			
θ	0°	12°	10°			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (SWP) (Type UX)



Dimensions	Value (in mm)
С	0.650
Х	0.420
X1	0.420
X2	0.230
X3	2.600
X4	3.500
Y	0.700
Y1	0.550
Y2	1.650
Y3	0.600
Y4	2.450
Y5	0.400
Y6	3.700

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device terminals and PCB tracking.



IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
 - 1. are intended to implant into the body, or
 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2019, Diodes Incorporated

www.diodes.com